## **/**\**V N E T**<sup>°</sup> **EMBEDDED**

### MSC HC-MB-EV

**COM-HPC®** Client Carrier



#### Description

The MSC HC-MB-EV is intended for design teams that require an easy and fast enablement of COM-HPC based solutions for lab evaluation, rapid prototyping and application development. Engineers can use it as a reference design for developing their own COM-HPC platform. The COM-HPC Client carrier provides a rich set of COM-HPC Client interfaces routed to the module socket including PCIe and PEG ports, DDI and eDP graphics interfaces, and high speed I/O like USB and SATA. COM-HPC Client modules of either Size A, B and C can be installed on the carrier.

#### Highlights

- Socket for COM-HPC® Client modules, Size A, B, C
- PCI Express x16 slot (PEG/general PCIe)
- PCI Express x16 slot (general PCIe)
- Three PCI Express slots 1x4
- Support for PCIe Gen 3 and 4
- Two SATA connectors
- M.2 socket for mass storage and AI modules
- Two USB4® Gen 2x2, Type-C connectors
- Two USB 3.2 Gen 2x1 Type-A connectors
- Two 1G/2.5G/10GBASE-T connectors (RJ45)
- Three DisplayPort connectors
- One eDP connector
- HDA audio codec
- Various additional COM-HPC® specific interfaces
- Power supply via ATX-style power connectors

- Wide power input range
- Size 305mm x 244mm (ATX)

# **/**\**VNET**<sup>°</sup>**EMBEDDED**

### **Technical Data - MSC HC-MB-EV**

Formfactor	ATX
Flash	M.2 socket for mass storage and AI modules:
	PCIe x4
	Card lengths 42/80/110 mm, M-key, max. 15W
Storage Interfaces	2x SATA up to 6Gb/s on on-board connectors
USB	2x USB4 Gen 2x2, Type-C connector on faceplate, 15W power delivery each
	2x USB 3.2 Gen 2x1, Type-A connector on faceplate
	4x USB 2.0 available on pin headers
	Supported USB modes depending on installed COM-HPC module capabilities
Bus Interfaces	PCI Express™ Gen 3 and 4
	One PEG port x16 on PCI Express x16 socket; max. 75W
	One PCI Express slots 1x16;
	Three PCI Express slots 1x4; one slot max. 25W, two slots max. 10W
	Maximum connectivity and bandwidth is determined by installed COM-HPC module and
	PCIe cards
Display Interfaces	DisplayPort:
	Three DisplayPort connectors on faceplate
	Embedded DisplayPort:
	One 40-pin eDP on-board connector
	MIPI CSI:
	Two MIPI CSI connectors on-board
	MIPI DSI:
	Module signals shared with eDP
Network Interface	Two RJ45 LAN connectors on faceplate
	Routed to COM-HPC module socket
	Support up 10/100/1000, 2.5GBASE-T or 10GBASE-T depending on installed
	COM-HPC module capabilities
	Two status LED's integrated per connector
Audio Interface	HDA audio codec Cirrus Logic CS4207
	Audio interfaces available at triple audio jack on faceplate:
	Line In, Line Out/Headphones, Microphone

# **/**\**V N E T**<sup>°</sup> **EMBEDDED**

Miscellaneous	Various pin-headers providing: GPIO, SMBus, I²C bus, SPI, power button, reset button, power conditions and other system signals	
	PORT 80 display	
	Serial high speed port: Two ports routed from module socket to on-board pin headers	
	BIOS Flash Pin-header for external BIOS Flash, selectable either on-board or on the module	
	Fan: 4 pin fan connector; PWM controlled by COM Express module	
	EEPROM One serial EEPROMs on I <sup>2</sup> C bus	
	Battery: CR 2032 type RTC battery (3V, socketed)	
Feature Highlights	Carrier board for COM-HPC® Client pin-out Note: availability and capabilities of interfaces determined by installed COM-HPC Client module and I/O cards.	
ower Requirement ATX supply via Standard 24pin ATX and ATX12V connectors Single voltage supply via ATX12V connector (optionally wide input range 8V to 20V)		
Environment	Ambient Temperature: 0° 60°C (operating), -25° 85°C (storage) Humidity: 5 95% (operating, non-condensing), 5 95% (storage, non-condensing)	
Dimensions	305mm x 244mm	

## **INVNET**<sup>°</sup> EMBEDDED

#### **Order Reference - MSC HC-MB-EV**

Order Number	Description	Reference	Cat*
tbd	COM-HPC Client Carrier Board with 1x PEG x16, 1x PCIe x16, 3x PCIe x4 slots; 2x USB 4.0 Gen 2.2, 2x USB 3.2 Gen 2x1, 2x 1G/2.5G/10GBASE-T, 2x SATA; 3x DisplayPort, 1x eDP, HDA audio; 1x M.2 socket; 24pin ATX and ATX12V power connectors; Dimensions: 305mm x 244mm (ATX form factor);	MSC HC-MB-EV	PV

\*COM products are divided in two categories, "PV" (preferred variant) and "OR" (on request).

Published: March 31, 2022 - 16:11:49

Avnet Embedded GmbH Industriestr. 16 76297 Stutensee

AvnetEmbedded@avnet.com avnet.com/embedded

Copyright © 2023 Avnet. All data is for information purposes only and is subject to change without notice. No guarantee for legal purposes is implied. Information in this document has been carefully checked, however, no responsibility for inaccuracies has to be assumed. All brand or product names may be trademarks and property of their respective owners.